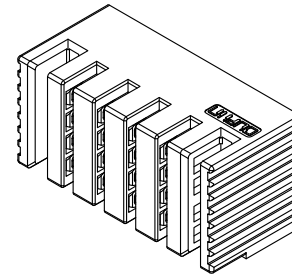
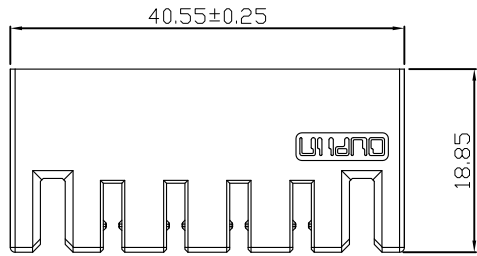


REV.	SPECIFICATION	ECN NO.	APPD.
R1		ECN241037	



Material and Plating:

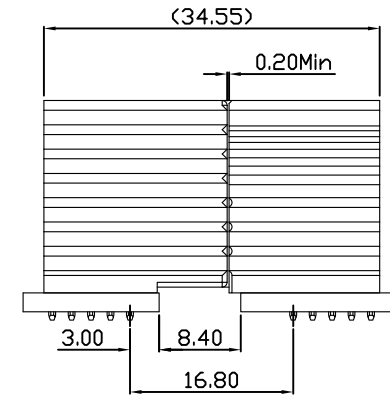
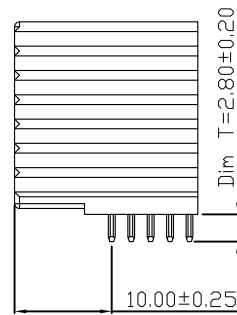
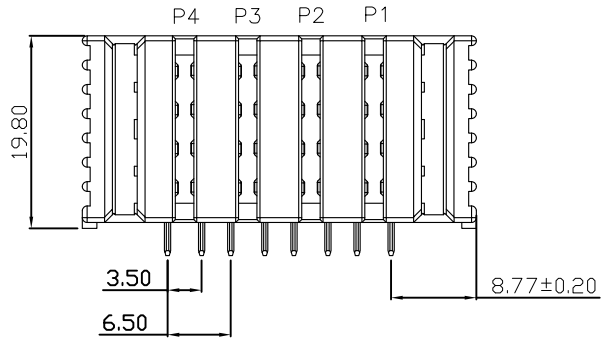
Housing: LCP, UL94V-0, Black.
 Contacts: High Conductivity Copper.
 Gold Plated on Contact Area and 80u" Min
 Tin Plated on Solder Tail over nickel 50u" Min .

Electrical Characteristics:

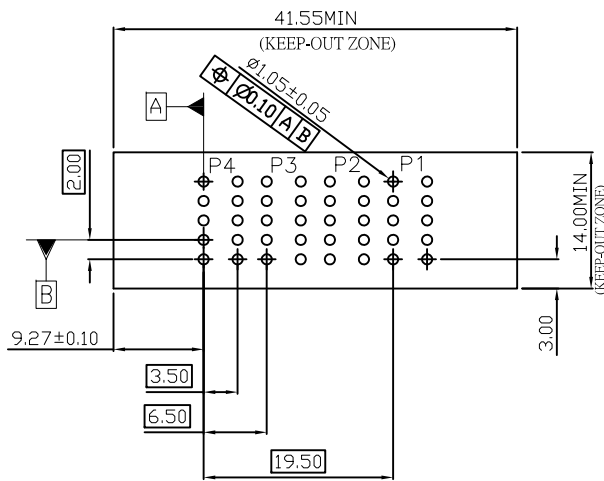
Current Rating: 100 AMP.
 Dielectric Withstanding Voltage: DC 1500V For 1 minute.
 Insulator Resistance: 1500MΩ min. at DC 500V.
 Contact Resistance: 0.70mΩ max.
 Operating Temperature: -55°C ~+125°C .

***RoHS Compliant**

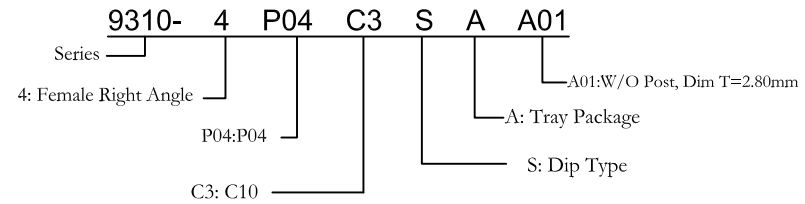
Note:
 1. IR Reflow & PIP



MATING BETWEEN MALE AND FEMALE



P.C.Board Layout(Top View)
 (Tolerance:±0.05)



Tolerances	Dwg. No.	9310-DP04-001		Title:
x = ±0.5	Projection	⊕ ↯		9310 Series
.x = ±0.25	Unit	mm	Scale	
.xx = ±0.15	Drawn By	WP 10/22'24		Receptable, Right Angle

OUPIN			
OUPIN ELECTRONIC(KUNSHAN) CO., LTD.			
P/N:9310-4P04C3SAA01			
SHEET	1/1	Ver. No.	R1